

Crystal LTD TM SPEC Form

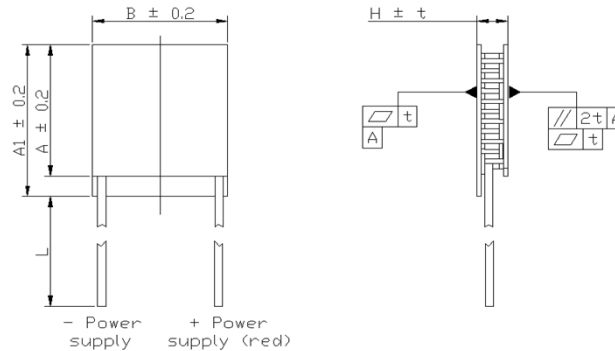
Customer

PO#
PO date

Thermoelectric module (TM) specification

PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	continuous operation	I _{max} , A	U _{max} , V	Q _{max} , W	dT _{max} , K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-071-10-08-L2	138	130	115	5.7	9.0	32.2	72.5	1.19	10	20/20	20	3.10	0.02	22	100	5	
															PVC			

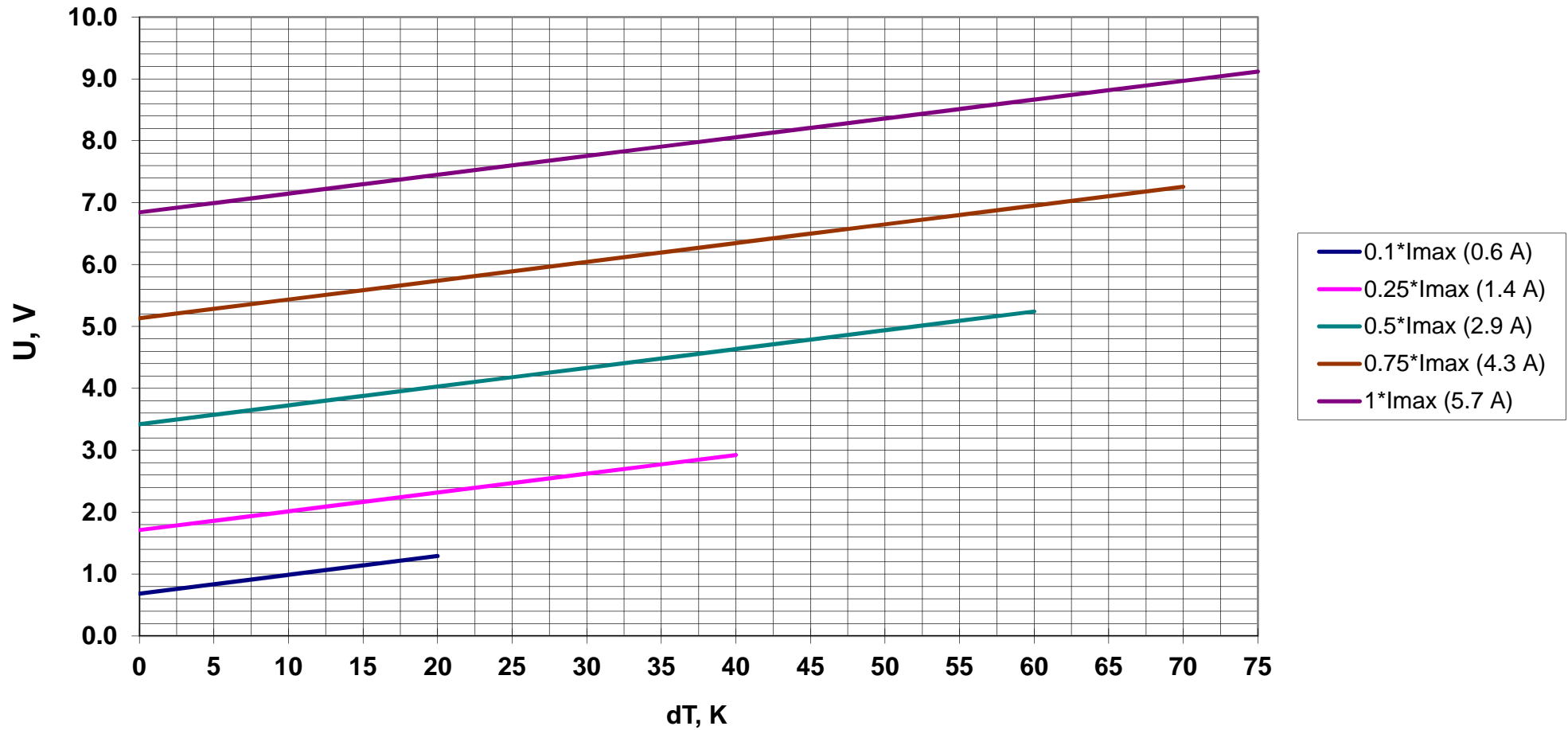
Clamping force: 8.6 - 17.1 kg



Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



U(dT) at Thot=298K



COP(dT)

